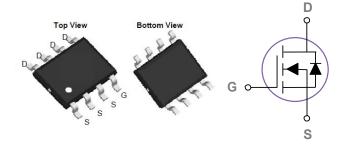


100V N-Channel MOSFET

General Description

The KSP4110 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible onresistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

SOP-8 Pin Configuration



Product Summary

V_{DS} (V)	$\mathbf{R}_{DS(on)}$ (m Ω)	I _D (A)
100	6.8 at VGS = 10 V	15
	8 at V _{GS} = 4.5 V	12

Features

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses

Applications

• Synchronous Rectification for AC/DC Quick Charger

Absolute Maximum Ratings Tc=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	100	V
Vgs	Gate-Source Voltage	±20	V
1-	Drain Current – Continuous (Tc=25℃)	15	А
lD	Drain Current – Continuous (Tc=100°C)	9.2	A
Ідм	Drain Current – Pulsed ¹	54	A
	Power Dissipation (Tc=25°C)	3.0	W
PD	Power Dissipation (Tc=100℃)	0.1	W/℃
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
R _{0JA}	Thermal Resistance Junction to ambient		57	°C/W
Rejc	Thermal Resistance Junction to Case		4.9	℃W

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Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100			V
IDSS	Drain-Source Leakage Current	V _{DS} =100V , V _{GS} =0V , T _J =25°C			1	uA
		V _{DS} =100V , V _{GS} =0V , TJ=125℃			20	uA
Igss	Gate-Source Leakage Current	V_{GS} = $\pm 20V$, V_{DS} = $0V$			±100	nA

On Characteristics

R _{DS(ON)} Static Drain-Sou	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =10A		6.8	9	mΩ
		V _{GS} =4.5V , I _D =8A		8	11	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.0	1.8	3	V
gfs	Forward Transconductance	V _{DS} =5V , I _S =8A		30		S

Dynamic and switching Characteristics

Qg	Total Gate Charge		 56	
Q _{gs}	Gate-Source Charge	V _{DS} =50V , V _{GS} =10V , I _D =10A	 9	 nC
Q _{gd}	Gate-Drain Charge		 6	
T _{d(on)}	Turn-On Delay Time		 9	
Tr	Rise Time	VDs=50V,RL=3.7 Ω	 6	 ns
T _{d(off)}	Turn-Off Delay Time	V _{GS} =10V,R _G =3Ω	 46	 115
Tf	Fall Time		 8	
Ciss	Input Capacitance		 3520	
Coss	Output Capacitance	V _{DS} =50V , V _{GS} =0V , F=1MHz	 275	 pF
C _{rss}	Reverse Transfer Capacitance		 110	

Drain-Source Diode Characteristics and Maximum Ratings

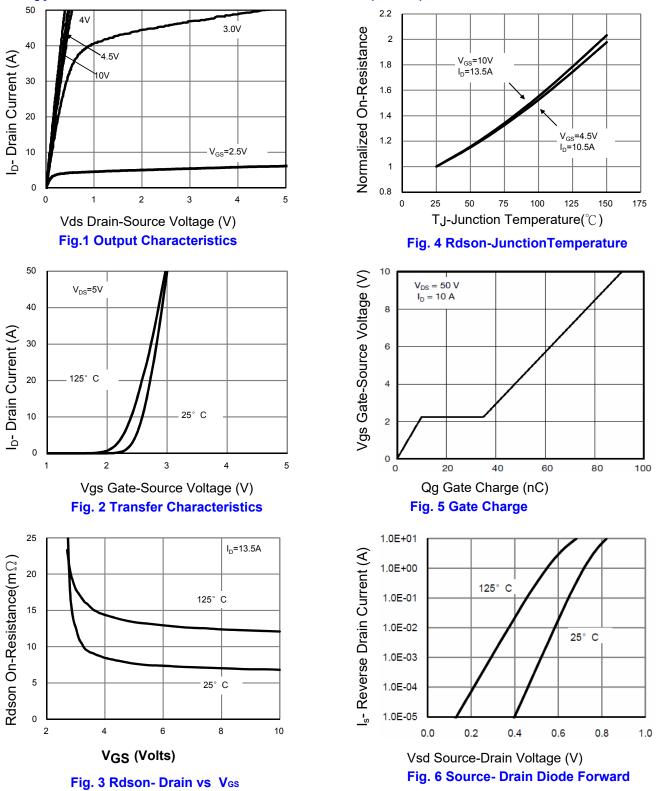
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current	$V_G=V_D=0V$, Force Current			15	А
lsм	Pulsed Source Current				45	А
Vsd	Diode Forward Voltage	V _{GS} =0V , Is=1A , Tյ=25℃			1.2	V

Note :

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production



100V N-Channel MOSFET



Typical Electrical and Thermal Characteristics (Curves)

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100V N-Channel MOSFET

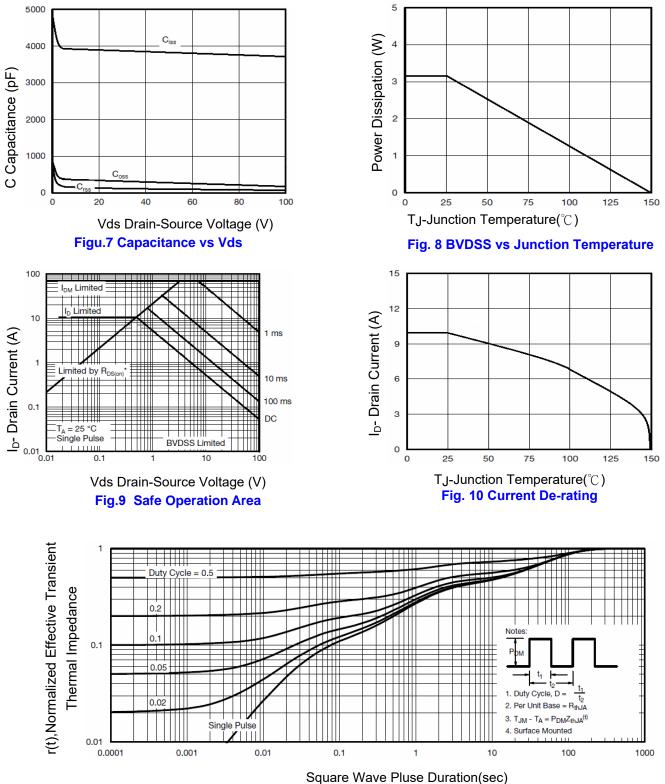


Fig.11 Normalized Maximum Transient Thermal Impedance



100V N-Channel MOSFET

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